

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- | | |
|---|---|
| <input checked="" type="checkbox"/> Advanced trench cell design | <input checked="" type="checkbox"/> Low Thermal Impedance |
| <input checked="" type="checkbox"/> Fast Switching Speed | <input checked="" type="checkbox"/> 100% Avalanche Tested |

1.2 Applications

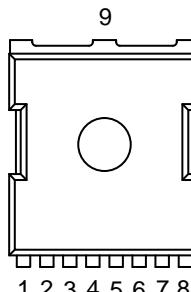
- | | |
|--|--|
| <input checked="" type="checkbox"/> DC/DC Conversion | <input checked="" type="checkbox"/> Power Switch |
| <input checked="" type="checkbox"/> Motor Drives | <input checked="" type="checkbox"/> Battery management |

1.3 Quick reference

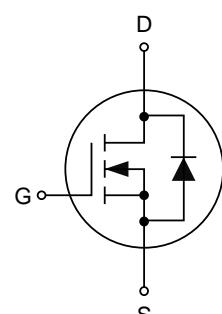
- | | |
|---|--|
| <input checked="" type="checkbox"/> BV \geq 110 V | <input checked="" type="checkbox"/> R _{DS(ON)} \leq 2.6 m Ω @ V _{GS} = 10 V |
| <input checked="" type="checkbox"/> P _D \leq 395 W | |
| <input checked="" type="checkbox"/> I _D \leq 260 A | |

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Gate		
2,3,4,5,6,7,8	Source		
9	Drain		



Top View
TOLL-8L



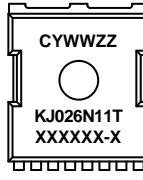
3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C=25^\circ C$	110	-	V
V_{GS}	Gate-Source Voltage	$T_C=25^\circ C$	-	± 20	V
I_D ***	Drain Current (DC)	$T_C=25^\circ C, V_{GS}=10 V$	-	260	A
		$T_C=100^\circ C, V_{GS}=10 V$	-	184	A
$I_{DM}^*, ***$	Drain Current (Pulsed)	$T_C=25^\circ C, V_{GS}=10 V$	-	1040	A
P_D	Drain Power Dissipation	$T_C=25^\circ C$	-	395	W
E_{AS}	Single Pulsed Avalanche Energy	$V_{DD}=55 V, L=0.5 mH$	-	1058	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range		-55	175	$^\circ C$
$R_{\theta JA}^{**}$	Thermal Resistance, Junction to Ambient		-	45	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		-	0.38	

Notes:

- * Pulse width $\leq 300 \mu s$, duty cycle $\leq 2\%$.
- ** Surface mounted on 1 in² pad area, $t \leq 10$ sec.
- *** Limited by bonding wire.

4. Marking Information

Product Name	Marking
KJ026N11T	

5. Ordering Code

Product Name	Package	Reel size	Tape width	Quantity (pcs)
KJ026N11T	TOLL-8L	13"	24 mm	2000

Note: KUAIJIEXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C).

6. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{DS}}=250 \mu\text{A}$	110	-	-	V
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{DS}}=250 \mu\text{A}$	2	-	4	V
I_{DSS}	Drain Leakage Current	$\text{V}_{\text{DS}}=80 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}$	-	-	1	μA
I_{GSS}	Gate Leakage Current	$\text{V}_{\text{DS}}=0 \text{ V}, \text{V}_{\text{GS}}=\pm 20 \text{ V}$	-	-	± 100	nA
$\text{R}_{\text{DS(ON)}}^{\text{a}}$	On-State Resistance	$\text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{DS}}=20 \text{ A}$	-	2.2	2.6	$\text{m}\Omega$
R_g	Gate Resistance	Frequency=1 MHz	-	3	-	Ω
Diode Characteristics						
$\text{V}_{\text{SD}}^{\text{a}}$	Diode Forward Voltage	$\text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{SD}}=20 \text{ A}, \text{V}_{\text{GS}}=0 \text{ V}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$\text{V}_{\text{DD}}=50 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{SD}}=20 \text{ A}, \text{dI/F/dt}=100 \text{ A}/\mu\text{s}$	-	90	-	ns
Q_{rr}	Reverse Recovery Charge		-	310	-	nC
Dynamic Characteristics ^b						
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=55 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}, \text{f}=1.0 \text{ MHz}$	-	9250	-	pF
C_{oss}	Output Capacitance		-	4080	-	
C_{rss}	Reverse Transfer Capacitance		-	285	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DD}}=55 \text{ V}, \text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{D}}=20 \text{ A}, \text{R}_{\text{GEN}}=6.5 \Omega$	-	40	-	ns
t_r	Turn-on Rise Time		-	55	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	112	-	
t_f	Turn-off Fall Time		-	62	-	
Gate Charge Characteristics ^b						
Q_g	Total Gate Charge	$\text{V}_{\text{DS}}=55 \text{ V}, \text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{D}}=20 \text{ A}$	-	135	-	nC
Q_{gs}	Gate-Source Charge		-	47	-	
Q_{gd}	Gate-Drain Charge		-	27	-	

Notes:

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

7. Typical Characteristics

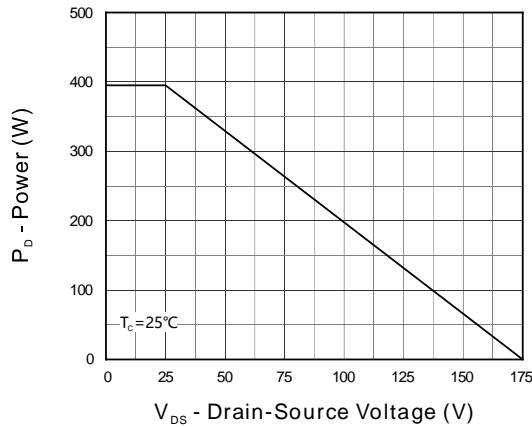


Figure 1. Output Characteristics

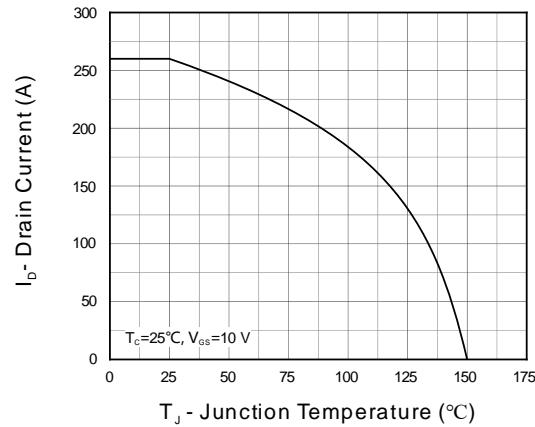


Figure 2. Current Capability

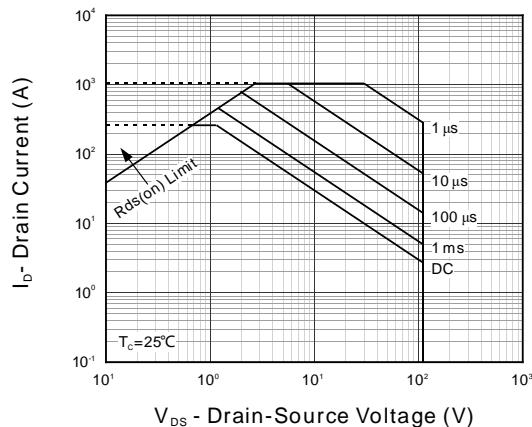


Figure 3. Safe Operation Area

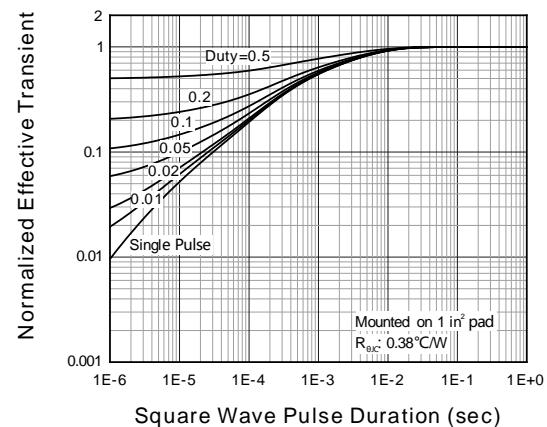


Figure 4. Transient Thermal Impedance

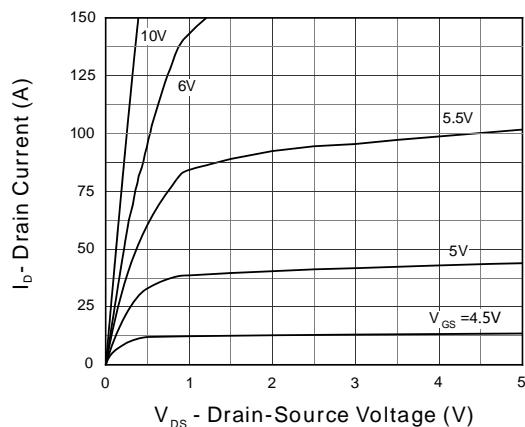


Figure 5. Output Characteristics

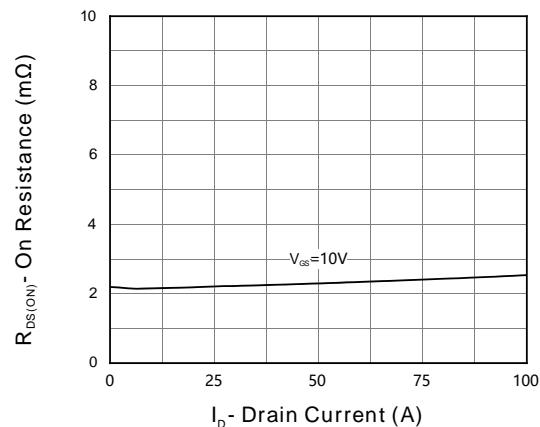


Figure 6. On Resistance

7. Typical Characteristics (cont.)

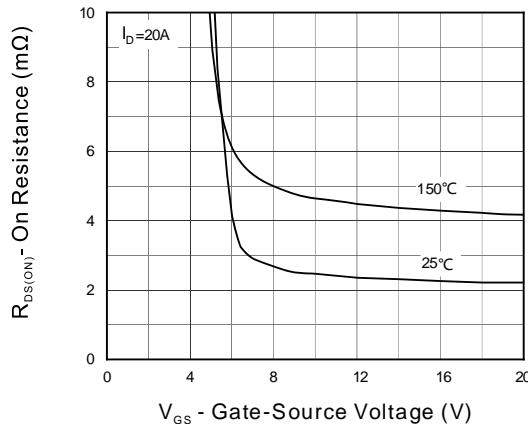


Figure 7. Transfer Characteristics

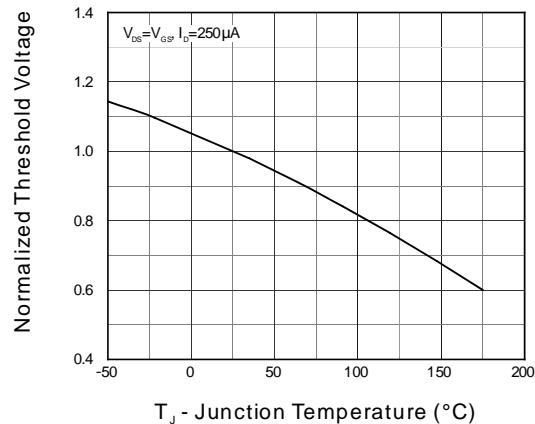


Figure 8. Normalized Threshold Voltage

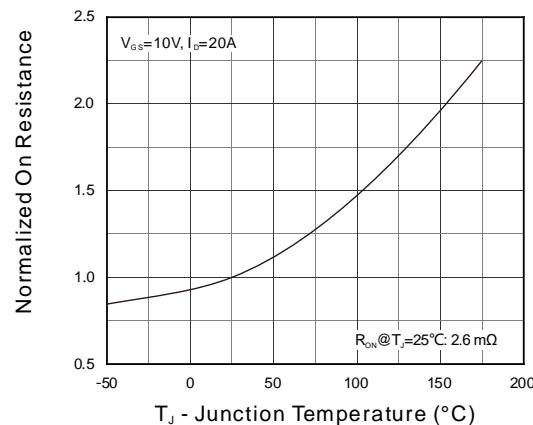


Figure 9. Normalized On Resistance

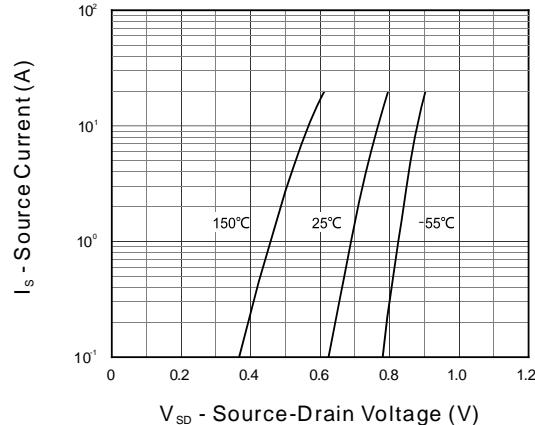


Figure 10. Diode Forward Current

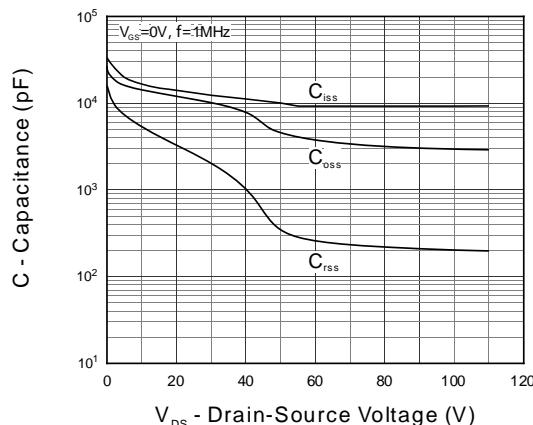


Figure 11. Capacitance

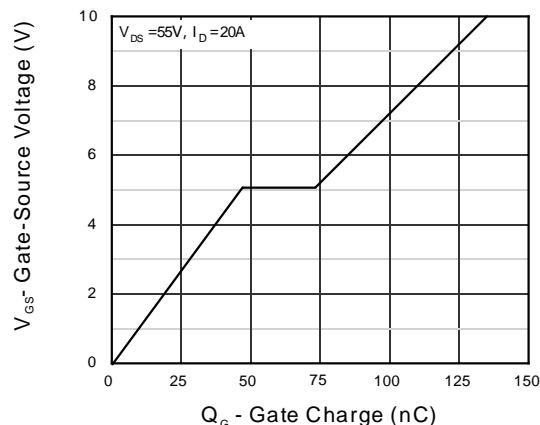
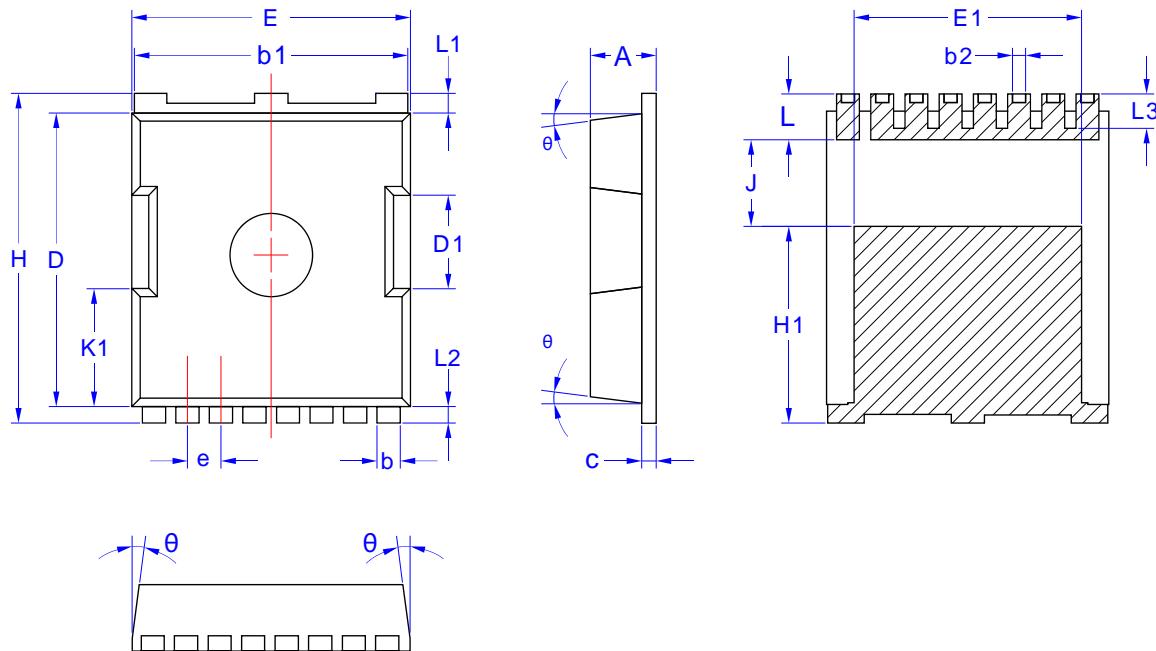


Figure 12. Gate Charge

8. Package Dimensions

TOLL-8L Package



Symbol	Dimensions in Millimeters	
	MIN	MAX
A	2.20	2.40
b	0.70	0.90
b1	9.70	9.90
b2	0.42	0.50
c	0.40	0.60
D	10.28	10.58
D1	3.10	3.50
E	9.70	10.10
E1	7.90	8.30
e	1.20 BSC	

Symbol	Dimensions in Millimeters	
	MIN	MAX
H	11.48	11.88
H1	6.75	7.15
J	3.00	3.30
K1	3.98	4.38
L	1.40	1.80
L1	0.60	0.80
L2	0.50	0.70
L3	1.00	1.30
θ	4°	10°